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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Majid et al.) Examiner: Parekh, N.
Application No.: 09/440,595)
Filed: 11/15/1999)
For: MULTIPLE SEMICONDUCTOR CHIP)
(MULTI-CHIP) MODULE FOR USE IN)
POWER APPLICATIONS)

Mail Stop Non-Fee Amendments
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

REQUEST FOR RECONSIDERATION

Sir:

In response to the Office Action of March 13, 2003, Applicants respectively request that the above-identified application be reconsidered in view of the remarks that follow, that each of the presently pending claims be allowed, and that the application be passed to issue.

REMARKS

Claims 1-7 are pending.

Claims 1-7 are rejected under 35 U.S.C. §103(a) as being unpatentable over Takagi et al. (US 6,130,458), hereafter “Takagi,” in view of Lauffer et al. (EP 0 471 938 A1), hereafter